

Wire-wound Metal Power Inductors MCOIL™ LSBH series

for General Electronic Equipment for Consumer

Wire-wound Metal Power Inductors MCOIL™ LSBH series (125°C guaranteed product)

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for Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)

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■ RELIABILITY DATA

1. Operating Temperature Range

Specified Value	−40~+105°C: LSBH/LLBH −40~+125°C: LSBH/LLBH (125°C guaranteed product)
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Test Methods and Remarks	Including self-generated heat
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2. Storage Temperature Range

Specified Value	−40~+85°C
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Test Methods and Remarks	0 to 40°C for the product with taping.
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3. Rated current

Specified Value	Within the specified tolerance
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4. Inductance

Specified Value	Within the specified tolerance
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Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 1MHz, 1V
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5. DC Resistance

Specified Value	Within the specified tolerance
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Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)
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6. Self resonance frequency

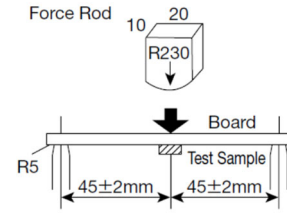
Specified Value	—
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7. Temperature characteristic

Specified Value	Inductance change : Within $\pm 15\%$
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Test Methods and Remarks	LSBH/LLBH: Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C}\sim +105^{\circ}\text{C}$. With reference to inductance value at $+20^{\circ}\text{C}$., change rate shall be calculated. LSBH/LLBH (125°C guaranteed product): Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C}\sim +125^{\circ}\text{C}$. With reference to inductance value at $+20^{\circ}\text{C}$., change rate shall be calculated.
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8. Resistance to flexure of substrate	
Specified Value	No damage
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.</p> <p>Test board size : 100 × 40 × 1.0 mm (1608 type: 0.8mm)</p> <p>Test board material : Glass epoxy-resin</p> <p>Solder cream thickness : 0.1 mm</p>



9. Insulation resistance : between wires	
Specified Value	—

10. Insulation resistance : between wire and core	
Specified Value	<p>LSBH/LLBH:</p> <p>DC25V 100kΩ min</p> <p>LSBH/LLBH (125°C guaranteed product):</p> <p>DC50V 100kΩ min</p>

11. Withstanding voltage : between wire and core	
Specified Value	—

12. Adhesion of terminal electrode	
Specified Value	No abnormality.
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow.</p> <p>Applied force : 10N (1608 type: 5N) to X and Y directions.</p> <p>Duration : 5s.</p> <p>Solder cream thickness : 0.1mm.</p>

13. Resistance to vibration															
Specified Value	<p>Inductance change : Within ±10%</p> <p>No significant abnormality in appearance.</p>														
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow.</p> <p>Then it shall be submitted to below test conditions.</p> <table border="1"> <tr> <td>Frequency Range</td> <td colspan="2">10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td colspan="2">1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td colspan="2">10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on each X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p>	Frequency Range	10~55Hz		Total Amplitude	1.5mm (May not exceed acceleration 196m/s ²)		Sweeping Method	10Hz to 55Hz to 10Hz for 1min.		Time	X	For 2 hours on each X, Y, and Z axis.	Y	Z
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14. Solderability							
Specified Value	At least 90% of surface of terminal electrode is covered by new solder.						
Test Methods and Remarks	<p>The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.</p> <p>Flux : Ethanol solution containing rosin 25%.</p> <table border="1"> <tr> <td>Solder Temperature</td> <td>245 ± 5°C</td> </tr> <tr> <td>Immersing speed</td> <td>25mm/s</td> </tr> <tr> <td>Time</td> <td>5 ± 0.5 sec.</td> </tr> </table> <p>※Immersion depth : All sides of mounting terminal shall be immersed.</p>	Solder Temperature	245 ± 5°C	Immersing speed	25mm/s	Time	5 ± 0.5 sec.
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15. Resistance to soldering heat

Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and Remarks	The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at 260+0/-5°C for 5 seconds, 3 times. Test board material : Glass epoxy-resin Test board thickness : 1.0mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

16. Thermal shock

Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.																																						
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17. Damp heat

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18. Loading under damp heat

Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.																		
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19. Low temperature life test

Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.				
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.</p> <table border="1" style="width: 100%; text-align: center;"> <tbody> <tr> <td>Temperature</td> <td>-40±2°C</td> </tr> <tr> <td>Time</td> <td>1000+24/-0 hour</td> </tr> </tbody> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p>	Temperature	-40±2°C	Time	1000+24/-0 hour
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▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

20. High temperature life test

Specified Value	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.				
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.				
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Time	$1000 + 24 / - 0$ hour				
Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.					

21. Loading at high temperature life test

Specified Value	—
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22. Standard condition

Specified Value	Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^\circ\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^\circ\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value.
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